



D-82205 Gilching

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03.2018

OLED 5.5" - 256x64 dots

Incl. controller SSD1322



Features

- 5.5" Low-Power OLED
- -40..+80°C (Top.)
- 256x64 dots
- Yellow display
- Incl. controller SSD1322
- SPI, 8-Bit Interface
- Fast response time (10µs) even at -40°C
- ZIFF connection
- 146x45mm outline dimensions

Ordering code

OLED 5.5" - 256x64 dots, yellow

EA W256064-XGLG

Accessory

ZIFF connector 30 pins, 0.5mm pitch, top contact

EA WF050-30T





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1. General Specification

Item	tem Dimension			
Dot Matrix	256 x 64 Dots	_		
Module dimension	146.0 × 45.0 × 2.05	mm		
Active Area	135.65 × 33.89	mm		
Pixel Size	0.5 × 0.5			
Pixel Pitch	0.53 × 0.53	mm		
Display Mode	Passive Matrix			
Display Color	Green			
Drive Duty	1/64 Duty			
IC	SSD1322			





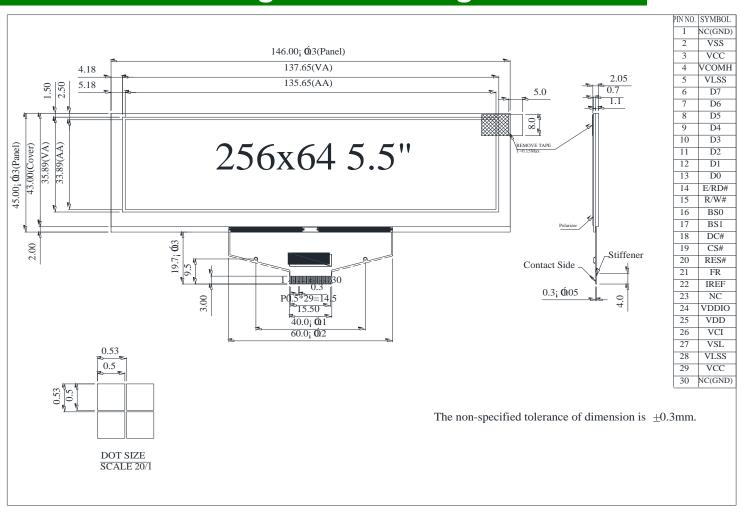
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2. Contour Drawing & Block Diagram







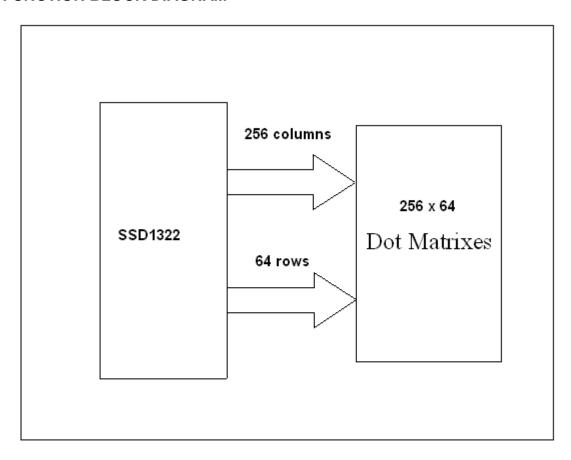
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FUNCTION BLOCK DIAGRAM







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3. Interface Pin Function

Pin	Symbol	I/O	Function
Power S	Supply		
26	VCI	Р	Power Supply for Operation This is a voltage supply pin. It must be connected to external source & always be equal to or higher than VDD & VDDIO.
25	VDD	Р	Power Supply for Core Logic Circuit This is a voltage supply pin. It can be supplied externally (within the range of 2.4~2.6V) or regulated internally from VCI. A capacitor should be connected between this pin & VSS under all circumstances.
24	VDDIO	Р	Power Supply for I/O Pin This pin is a power supply pin of I/O buffer. It should be connected to VDD or external source. All I/O signal should have VIH reference to VDDIO. When I/O signal pins (BS0~BS1, D0~D7, control signals) pull high, they should be connected to VDDIO.
2	VSS	Р	Ground of Logic Circuit This is a ground pin. It also acts as a reference for the logic pins. It must be connected to external ground.
3,29	VCC	Р	Power Supply for OLED Panel These are the most positive voltage supply pin of the chip. They must be connected to external source.
5,28	VLSS	Р	Ground of Analog Circuit These are the analog ground pins. They should be connected to VSS externally.
Driver			
22	IREF	I	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 10uA.
4 VCOMH P Voltage Output High Level for COM Signal This pin is the input pin for the voltage output signals. A tantalum capacitor should be conne		This pin is the input pin for the voltage output high level for COM signals. A tantalum capacitor should be connected between this pin and VSS.	
27	VSL	Р	Voltage Output Low Level for SEG Signal This is segment voltage reference pin. When external VSL is not used, this pin should be left open. When external VSL is used, this pin should connect with resistor and diode to ground.





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21	FR	0	This pin is No Connection pins. Nothing should be connected						
			this pin. This pin should be left open individually.						
16	BS0	I	Communicating Protocol Select						
17	BS1		These pins are MCU interface select	tion input.	See the fo	ollowing			
			table:						
				BS0	BS1				
			3-wire SPI	1	0				
			4-wire SPI	0	0				
			8-bit 68XX Parallel	1	1				
			8-bit 80XX Parallel	0	1				
20	RES#	1	Power Reset for Controller and D	river		-			
			This pin is reset signal input. When	the pin is	low, initial	ization			
			of the chip is executed.	-					
19	CS#	1	Chip Select						
			This pin is the chip select input. The	•	nabled for	MCU			
			communication only when CS# is p	ulled low.					
18	D/C#	I	Data/Command Control						
			This pin is Data/Command control p		•	pulled			
			high, the input at D7~D0 is treated						
			When the pin is pulled low, the input transferred to the command registe			hin to			
			MCU interface signals, please refer		ii reialions	stilp to			
			Timing Characteristics Diagrams.	to the					
14	E/RD#	1	Read/Write Enable or Read						
			This pin is MCU interface input. Wh	en interfac	cing to a				
			68XX-series microprocessor, this p			9			
			Enable (E) signal. Read/write opera	ation is initi	iated wher	n this			
			pin is pulled high and the CS# is pu						
			When connecting to an 80XX-micro	•	•				
			the Read (RD#) signal. Data read o	-	s initiated v	when			
			this pin is pulled low and CS# is pul						
			When serial mode is selected, this	oin must b	e connect	ed to			
15	R/W#	1	VSS. Read/Write Select or Write						
15	N/ VV#	ı	This pin is MCU interface input. Wh	en interfa	ring to a				
			68XX-series microprocessor, this pi		•				
			Read/Write (R/W#) selection input.			" for			
			read mode and pull it to "Low" for w	•	_				
			When 80XX interface mode is selected, this pin will be the						
			Write (WR#) input. Data write opera						
			pin is pulled low and the CS# is pul						





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			When serial mode is selected, this pin must be connected to VSS.
6~13	D7~D0	I/O	Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. Unused pins must be connected to VSS except for D2 in serial mode.
Reserve	•		
23	N.C.	-	Reserved Pin The N.C. pin between function pins are reserved for compatible and flexible design.
1,30	N.C. (GND)	-	Reserved Pin (Supporting Pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.





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4. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Operation	VCI	-0.3	4	V	1, 2
Supply Voltage for Logic	VDD	-0.5	2.75	V	1, 2
Supply Voltage for I/O Pins	VDDIO	-0.5	VCI	V	1, 2
Supply Voltage for Display	VCC	-0.5	20	V	1, 2
Operating Temperature	TOP	-40	80	°C	-
Storage Temperature	TSTG	-40	80	°C	-

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate





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5. Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Operation	VCI	Note	2.8	3.0	3.3	V
Supply Voltage for Display	VCC	_	14	14.5	16	V
High Level Input	VIH	_	0.8×VDDIO	_	VDDIO	V
Low Level Input	VIL	_	0	_	0.2×V _{DDIO}	V
High Level Output	VOH	_	0.9×VDDIO	_	VDDIO	V
Low Level Output	VOL	_	0	_	0.1×V _{DDIO}	V
50% Check Board operating Current		VCC =14.5V	34	36	45	mA

Note: Supply Voltage for Logic = VDD core power supply can be regulated from VCI.





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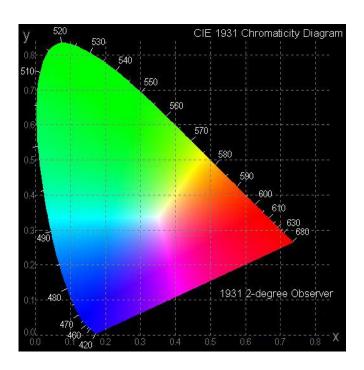
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6. Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	(V)θ		160			deg
View Angle	(Η)φ		160			deg
Contrast Ratio	CR	Dark	2000:1		_	_
Deepenso Time	T rise	_		10		μs
Response Time	T fall	_		10		μs
Display with 50% check	Display with 50% check Board Brightnes		60	80		cd/m2
CIEx(Green)		(CIE1931)	0.24	0.28	0.32	
CIEy(Green)	CIEy(Green)		0.59	0.63	0.67	







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7. OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25°C / Initial 50% check board brightness Typical Value	40,000 Hrs	-	Note

Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.





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8. Reliability

Content of Reliability Test

Environmenta	Il Test		
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 240hrs	
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40°C 240hrs	
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80°C 240hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40°C 240hrs	
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C,90%RH 240hrs	
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40°C 25°C 80°C 30min 5min 30min 1 cycle	-40°C/80°C 100 cycles	
Mechanical Te	st		
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hr	
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sin wave 11 ms 3 times of each direction	
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115mbar 40hrs	
Others			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times	

^{***} Supply voltage for OLED system =Operating voltage at 25°C





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Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

APPENDIX:

RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.





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9. Inspection specification

NO	Item	Criterion					AQL
01	Electrical	•	I.1 Missing vertical, horizontal segment, segment contrast				
	Testing	defect.					
		1.2 Missing character , dot or icon.					
		1.3 Display malfun	ction.				
		1.4 No function or	no dis	play	' .		0.65
		1.5 Current consur	nptior	exc	ceeds product	specifications.	0.00
		1.6 OLED viewing	angle	def	ect.		
		1.7 Mixed product	types				
		1.8 Contrast defect.					
02	Black or white	2.1 White and blac	k eno	te or	n dienlay <0.24	5mm, no more than	
02	spots on OLED	three white or blac	-			ommi, no more trian	
	(display only)	2.2 Densely space	•	•		nts or lines within	2.5
	(diopidy offiy)	3mm.	u. 110		o triair two opt	oto or inico within	
03	OLED black	3.1 Round type : A	s follo	win	g drawing		
	spots, white	$\Phi = (x + y) / 2$			SIZE	Acceptable Q	
	spots,	→ _X ⊬ – <u>↓</u>				TY	
	contamination	→			Ф≦0.10	Accept no	
	(non-display)					dense	2.5
		ı.			0.10<Φ≦	2	2.5
					0.20		
					0.20<Φ≦	1	
					0.25		
					0.25<Ф	0	
		3.2 Line type : (As following drawing)					
		Ler	gth	Wi	dth	Acceptable Q TY	
				W	≦0.02	Accept no dense	2.5
			3.0		02 <w≦0.03< td=""><td>2</td><td></td></w≦0.03<>	2	
		L≦	2.5	0.0	03 <w≦0.05< td=""><td>_</td><td></td></w≦0.05<>	_	





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		<u>\</u> <u>\</u> <u>\</u> <u>\</u> <u>\</u> <u>\</u> <u>\</u> <u>\</u>	0.05 < W	As round type	
04	Polarizer bubbles	If bubbles are visible, judge using black sponsore specifications, not easy to find, must check in specify direction.	+ :0.00	Acceptable Q TY Accept no dense 3 2 0 3	2.5

NO	Item	Criterion			AQL	
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination				
06	Chipped glass	Symbols Define: x: Chip length k: Seal width L: Electrode pad leng 6.1 General glass chi 6.1.1 Chip on panel s	t: Glass thickness a gth: ip:	: OLED side length	2.5	
		Z≦1/2t	Not over viewing	x≤1/8a		





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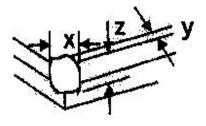
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	area	
1/2t < z ≤ 2t	Not exceed 1/3k	x≦1/8a

⊙ If there are 2 or more chips, x is total length of each chip.

6.1.2 Corner crack:



z: Chip thickness	y: Chip width	x: Chip length	
Z≦1/2t	Not over viewing	x≦1/8a	
	area		
1/2t < z ≤ 2t	Not exceed 1/3k	x≦1/8a	
Olf the are and O an areas ables as in the total legath of each able			

⊙ If there are 2 or more chips, x is the total length of each chip.





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NO	Item	Criterion			AQL
		Symbols :			
		x: Chip length y: 0	Chip width z: Ch	nip thickness	
		k: Seal width t: 0	Glass thickness a: 0	OLED side length	
		L: Electrode pad length			
		6.2 Protrusion over term	ninal :		
		6.2.1 Chip on electrode	pad:		
06	Glass	y≤0.5mm x 6.2.2 Non-conductive poly y: Chip width y≤ L ⊙ If the chipped area to must remain and be i specifications. ⊙ If the product will be here.	≤ 1/8a ortion: x: Chip length x≤ 1/8a uches the ITO terminates according to the according to the color of the color o	to electrode terminal	2.5
		mark not be damaged.			





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6.2.3 Substrate protube	erance and internal	crack.	
X	y: width	x: length	
	y≦1/3L	x ≦ a	
У			_
080			





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NO	Item	Criterion	AQL
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB、COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, OLED pad, zebra pad 	2.5 2.5 0.65 2.5 0.65 2.5





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		or screw hold pad, make sure it is smoothed down.	
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65





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NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on	2.5
		product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the	
		interface pin must be present or look as if it cause the	2.5
12	General	interface pin to sever.	
12	appearance	12.6 The residual rosin or tin oil of soldering (component or	2.5
		chip component) is not burned into brown or black color.	0.65
		12.7 Sealant on top of the ITO circuit has not hardened.	0.65
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 OLED pin loose or missing pins.	
		12.10 Product packaging must the same as specified on	0.65
		packaging specification sheet.	
		12.11 Product dimension and structure must conform to	
		product specification sheet.	





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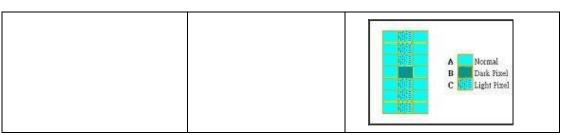
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Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Short	Major	
Wrong Display	Major	
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	





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10. Precautions in use of OLED Modules

Modules

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- (3)Don't disassemble the OLED display module.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist OLED display module.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8)It's pretty common to use "Screen Saver" to extend the lifetime and Don't use fix information for long time in real application.
- (9)Don't use fixed information in OLED panel for long time, that will extend "screen burn" effect time..
- (10)ELECTRONIC ASSEMBLY has the right to change the passive components, including R2and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11) ELECTRONIC ASSEMBLY have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, ELECTRONIC ASSEMBLY have the right to modify the version.)

11.1. Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It





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takes advantage of by using following adhesion tape.

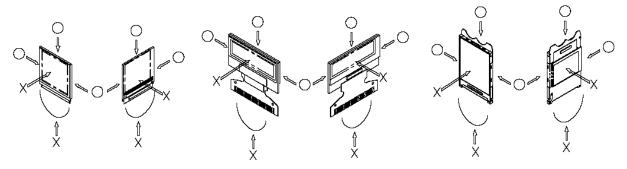
* Scotch Mending Tape No. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- * Water
- * Ketone
- * Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts.

These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- (7) Do not apply stress to the LSI chips and the surrounding molded sections.
- (8) Do not disassemble nor modify the OLED display module.
- (9) Do not apply input signals while the logic power is off.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
- * Be sure to make human body grounding when handling OLED display modules.
- * Be sure to ground tools to use or assembly such as soldering irons.
- * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- * Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.
- (11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the





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surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.

(12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

11.2. Storage Precautions

(1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments.

(We recommend you to store these modules in the packaged state when they were shipped from ELECTRONIC ASSEMBLY.

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

(2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

11.3. Designing Precautions

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) When fastening the OLED display module, fasten the external plastic housing section.
- (7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.
- * Connection (contact) to any other potential than the above may lead to rupture of the IC.





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11.4. Precautions when disposing of the OLED display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

11.5. Other Precautions

- (1) When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
- Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- (2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
- * Pins and electrodes
- * Pattern layouts such as the TCP & FPC
- (3) With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
- * Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
- * Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
- (4) Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- (5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (6)Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.
- (7)Our company will has the right to upgrade and modify the product function.
- (8) The limitation of FPC bending

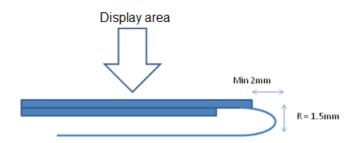




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11.Initialization example

```
******************
Global variables
******************************
uint8_t buf[20];
                             //SPI command buffer
uint8_t buffer[128];
                             //SPI data buffer
const uint8_t lookupval[4] = {0x0,0xF,0xF0,0xFF}; //lookup table
/***********************************
Function name: command
Description: send command via SPI
************************************
void command(uint8_t command){
   waitforemptybuffer(); //waits until SPI buffer is empty
   buf[0] = command;
   PORT5.PODR.BIT.B4 = 0; //set D/C# pin low
   R_RSPI0_Send(buf,1); //send buffer via SPI
}
/***********************************
Function name: data
Description: send data via SPI
*****************************
void data(uint8_t data){
    waitforemptybuffer();  //waits until SPI buffer is empty
   buf[0] = data;
   PORT5.PODR.BIT.B4 = 1;  //set D/C# pin high
   R_RSPI0_Send(buf,1); //send buffer via SPI
}
```





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```
/***********************************
Function name: initW256064
Description: Initialization of the display
void initW256064 (void){
     PORT5.PODR.BIT.B5 = 0;
                                 //Reset pin low
                             //100ms delay
   ms_delay(100);
   PORT5.PODR.BIT.B5 = 1;
                                 //Reset pin high
                              //100ms delay
   ms_delay(100);
     command(0xFD); //set Command unlock
   data(0x12);
   command(0xAE); //set display off
   command(0xB3);
                  //set display clock divide ratio...
   data(0x91);
                  //...to 135 Frames/sec
   command(0xCA);
                  //set multiplex ratio...
   data(0x3F);
                  //...to 64-1
   command(0xA2);
                  //set display offset
   data(0x00);
                  //...to 0
                  //start display start line
   command(0xA1);
                  //...to 0
   data(0x00);
   command(0xA0);
                  //set Re-Map & Dual COM Line Mode
   data(0x14);
   data(0x11);
   command(0xB5);
                  //disable IO intput
```





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```
data(0x00);
command(0xAB);
                   //function select
data(0x01);
command(0xB4);
                  //enable VSL extern
data(0xA0);
data(0xFD);
command(0xC1);
                  //set contrast current
data(0xFF);
command(0xC7);
                  //set master contrast current
data(0x0F);
  command(0xB8); //set gray scale table
data(0x00);
data(0x00);
data(0x00);
data(0x03);
data(0x06);
data(0x10);
data(0x1D);
data(0x2A);
data(0x37);
data(0x46);
data(0x58);
data(0x6A);
data(0x7F);
data(0x96);
data(0xB4);
command(0xB1);
                  //set phase length
data(0xE8);
```





}

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```
command(0xD1);
                 //enhance driving scheme capability
data(0x82);
data(0x20);
command(0xBB);
                 //first pre charge voltage
data(0x1F);
command(0xB6);
                  //second pre charge voltage
data(0x08);
command(0xBE);
                  //VCOMH
data(0x07);
command(0xA9);
                 //no partial mode
                  //set normal display mode
command(0xA6);
ms_delay(1); //stabilize VDD
command(0xAF);
                  //display on
ms_delay(200);
                  //stabilize VDD
```





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```
Function name: initWindow
Description: Initialization of the window in horizontal addressing mode
************************************
void initWindow(uint8_t startcol, uint8_t stopcol, uint8_t startrow, uint8_t stoprow){
   command(0x15);
   data(28+startcol);
   data(28+stopcol);
   command(0x75);
   data(startrow);
   data(stoprow);
   command(0x5C);
   ms_delay(50);
}
/*******************************
Function name: sendDataW256064
Description: Sends data to the display (Initialization of the window before sending data to
the display -> initWindow()
Display controller provides 4Bit grayscale -> function only use monochrome data
*******************************
void sendDataW256064 (const uint8_t *tx_buf, uint16_t tx_num){
     uint16_t i,j,w;
   uint16_t count, totcount;
   uint8 t byte;
   count = 0;
   totcount = 2;
```





0000

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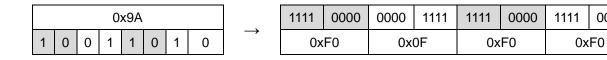
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```
//convert monochrome pixel data to 4Bit grayscale 0->0000; 1->1111
    for (j=0;j<64;j++){</pre>
                                 //all 64 rows
            waitforemptybuffer(); //Waits until SPI buffer is empty
        for(i=0;i<32;i++){</pre>
            totcount++;
            for(w=0;w<4;w++){</pre>
                buffer[count] = lookupval[(byte & 0xC0)>>6];
                byte = byte << 2;
                count++;
            }
        }
        PORT5.PODR.BIT.B4 = 1;
                                    //D/C# pin high
        R_RSPI0_Send(&buffer,128); //send data buffer via SPI (one row)
        count = 0;
    }
}
```

Convertion example of one monochrome data byte (8 pixel) to 4Bit grayscale data:

1 byte monochrome data

→ 4 bytes grayscale data



2048 data bytes $tx_buf[]$ \rightarrow 64x128 data bytes buffer[]





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12. Application example

